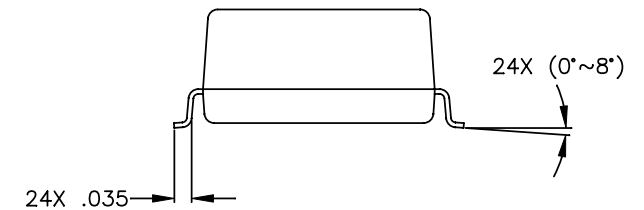
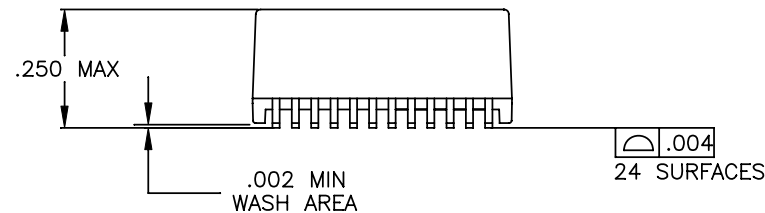
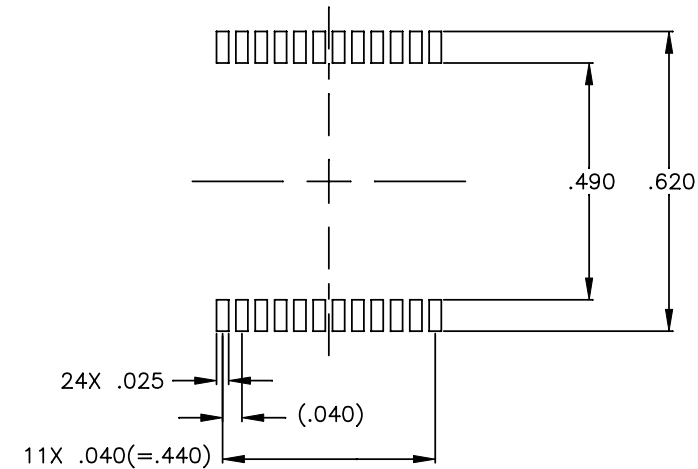
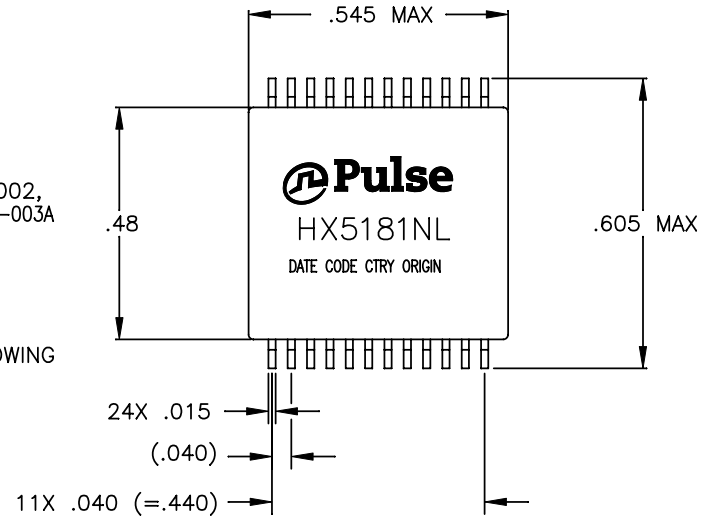


NOTES: UNLESS OTHERWISE SPECIFIED

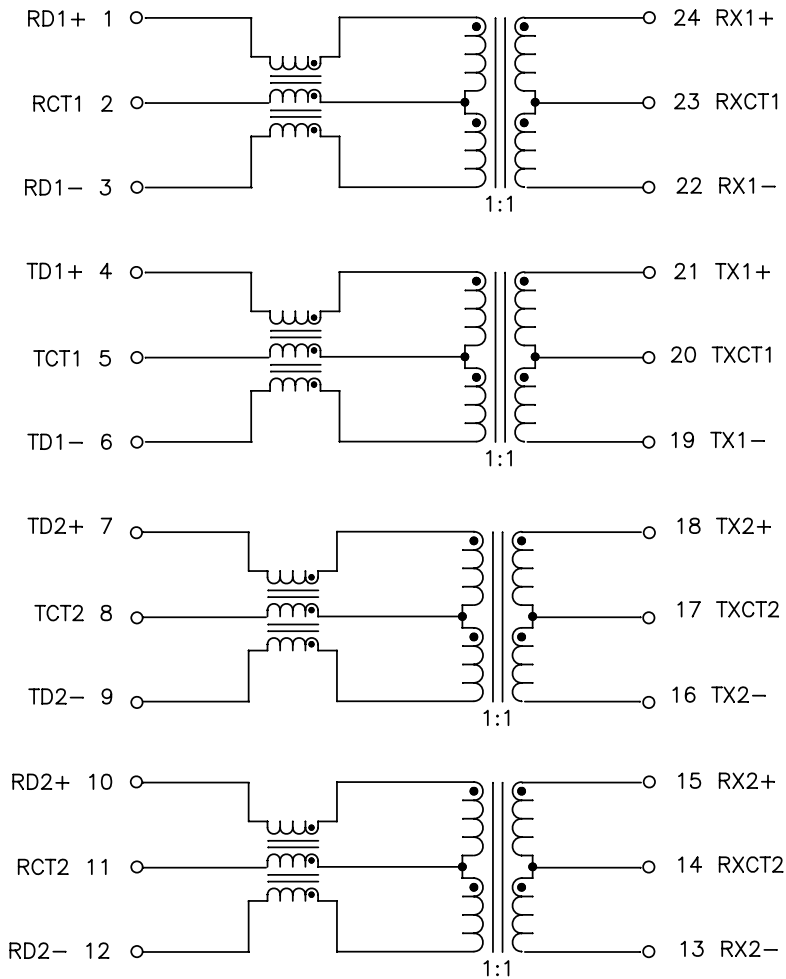
1.

NOTICE:	THIS IS A RoHS COMPLIANT COMPONENT/PRODUCT. ALL ENGINEERING CHANGES MUST HAVE PRIOR APPROVAL BY THE DESIGN CENTER.
RoHS	
2. PLASTIC: THERMOSET PLASTIC MATERIAL WITH FLAMMABILITY RATING UL 94V-0 OR BETTER.
3. SOLDERABILITY: CONFORMS TO ANSI/J-STD-002, 245°C REFLOW PEAK TEMPERATURE PER IPC/EIA J-STD-003A
4. OPERATING TEMPERATURE: -40°C TO +85°C
5. STORAGE TEMPERATURE: -50°C TO +125°C
6. JEDEC MOISTURE: LEVEL 1.
7. DIMENSIONS ARE IN INCHES WITH THE FOLLOWING TOLERANCES:
.XX= ±.02
.XXX= ±.010
8. REVISION: MP1,MP2, ARE PRELIMINARY.



© Copyright, 2013. Pulse Electronics Corp. All rights reserved. Drawing specifications subject to change without notice. (08/08/13)

PULSE CONFIDENTIAL & PROPRIETARY	PRODUCT DESCRIPTION	PS DRAWING	SHEET:	DWG. NO./ PART NO.	REV.
	MDL,SIN,1GD,1:1,SM,TU	PS-2337.002-A	1	HX5181NL	M12



SCHEMATIC

ELECTRICAL CHARACTERISTICS AT +25°C

PARAMETER	SPECIFICATIONS	
OPERATING TEMP	-40°C ~ +85°C	
TURNS RATIO	1 : 1 ±2%	
POLARITY	PER SCHEMATIC	
INSERTION LOSS	100 KHz	1-125 MHz
	-1.2 dB MAX	-0.2-0.002*f ^{1.4} dB MAX
RETURN LOSS, 1000BT (Z OUT = 100 OHM ±15%)	.1-40 MHz	40-100 MHz
	-16 dB MIN	-10+20*LOG ₁₀ (f/80 MHz) dB MIN
INDUCTANCE (OCL) (MEDIA SIDE, -40°C-85°C)	350 uH MIN (MEASURED AT 100 KHz, 100 mVRMS AND WITH 8 mA DC BIAS)	
CROSSTALK, ADJACENT CHANNELS	1 MHz	10-100 MHz
	-50 dB MIN	-55+22*LOG ₁₀ (f/10) dB MIN
DIFFERENTIAL TO COMMON MODE REJECTION	2 MHz	30-200 MHz
	-50 dB MIN	-43+22*LOG ₁₀ (f/30) dB MIN
DC RESISTANCE, 1/2 WINDING	.65 OHMS MAX	
DC RESISTANCE IMBALANCE	±.065 OHMS MAX (CENTER TAP SYMMETRY)	
INPUT - OUTPUT ISOLATION	1500 VRMS MIN @ 60 SECONDS	

NOTE: f IS FREQUENCY IN MHz.